

TC682

Inverting Voltage Doubler

Features:

- 99.9% Voltage Conversion Efficiency
- 92% Power Conversion Efficiency
- Wide Input Voltage Range:
 - +2.4V to +5.5V
- Only 3 External Capacitors Required
- 185 µA Supply Current
- Space-Saving 8-Pin SOIC and 8-Pin PDIP Packages

Applications:

- -10V from +5V Logic Supply
- -6V from a Single 3V Lithium Cell
- Portable Handheld Instruments
- Cellular Phones
- LCD Display Bias Generator
- · Panel Meters
- Operational Amplifier Power Supplies

Device Selection Table

Part Number	Package	Operating Temp. Range
TC682COA	8-Pin SOIC	0°C to +70°C
TC682CPA	8-Pin PDIP	0°C to +70°C
TC682EOA	8-Pin SOIC	-40°C to +85°C
TC682EPA	8-Pin PDIP	-40°C to +85°C

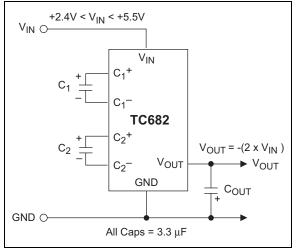
General Description:

The TC682 is a CMOS charge pump converter that provides an inverted doubled output from a single positive supply. An on-board 12 kHz (typical) oscillator provides the clock and only 3 external capacitors are required for full circuit implementation.

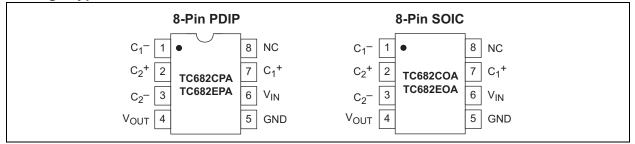
Low output source impedance (typically 140Ω), provides output current up to 10 mA. The TC682 features low quiescent current and high efficiency, making it the ideal choice for a wide variety of applications that require a negative voltage derived from a single positive supply (for example: generation of -6V from a 3V lithium cell or -10V generated from a +5V logic supply).

The minimum external parts count and small physical size of the TC682 make it useful in many mediumcurrent, dual voltage analog power supplies.

Functional Block Diagram



Package Type



© 2002-2012 Microchip Technology Inc.

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings*

V _{IN} +5.8V
$V_{\text{IN}}dV/dT\dots\dots1V/\mu\text{sec}$
V _{OUT} 11.6V
Short-Circuit Duration - V _{OUT} Continuous
Power Dissipation ($T_A \le 70^{\circ}C$)
8-Pin PDIP730 mW
8-Pin SOIC470 mW
Operating Temperature Range40°C to +85°C
Storage Temperature (Unbiased)65°C to +150°C

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

TC682 ELECTRICAL SPECIFICATIONS

Electrical Characteristics: Over operating temperature range, V _{IN} = +5V, test circuit Figure 3-1 unless otherwise noted.						
Symbol	Parameter	Min	Тур	Max	Units	Test Conditions
V _{IN}	Supply Voltage Range	2.4		5.5	V	$R_L = 2 k\Omega$
I _{IN}	Supply Current	_	185 —	300 400	μΑ	$R_{L} = \infty, T_{A} = 25^{\circ}C$ $R_{L} = \infty$
R _{OUT}	V _{OUT} Source Resistance	-	140 — 170	180 230 320	Ω	$I_{L}^{-} = 10 \text{ mA}, T_{A} = 25^{\circ}\text{C}$ $I_{L}^{-} = 10 \text{ mA}$ $I_{L}^{-} = 5 \text{ mA}, V_{IN} = 2.8\text{V}$
F _{OSC}	Oscillator Frequency	-	12	_	kHz	
P _{EFF}	Power Efficiency	90	92	_	%	$R_L = 2 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$
VOUTEFF	Voltage Conversion Efficiency	99	99.9	_	%	$V_{OUT}, R_L = \infty$

2.0 PIN DESCRIPTION

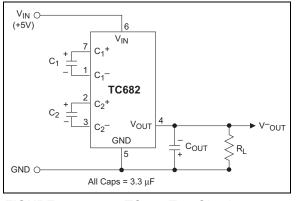
The descriptions of the pins are listed in Table 2-1.

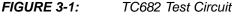
TABLE 2-1: PIN FUNCTION TABLE

Pin No. (8-Pin PDIP, SOIC)	Symbol	Description
1	C1–	Input. Capacitor C1 negative terminal.
2	C2+	Input. Capacitor C2 positive terminal.
3	C2–	Input. Capacitor C2 negative terminal.
4	V _{OUT}	Output. Negative output voltage (-2V _{IN}).
5	GND	Input. Ground.
6	V _{IN}	Input. Power supply voltage.
7	C1+	Input. Capacitor C1 positive terminal.
8	NC	No connection.

^{© 2002-2012} Microchip Technology Inc.

3.0 DETAILED DESCRIPTION





3.1 Phase 1

 V_{SS} charge storage – before this phase of the clock cycle, capacitor C_1 is already charged to +5V. C_1^+ is then switched to ground and the charge in C_1^- is transferred to C_2^- . Since C_2^+ is at +5V, the voltage potential across capacitor C_2 is now -10V.

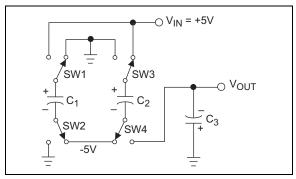


FIGURE 3-2: Charge Pump – Phase 1

3.2 Phase 2

 V_{SS} transfer – phase two of the clock connects the negative terminal of C_2 to the negative side of reservoir capacitor C_3 and the positive terminal of C_2 to ground, transferring the generated -10V to C_3 . Simultaneously, the positive side of capacitor C_1 is switched to +5V and the negative side is connected to ground. C_2 is then switched to V_{CC} and GND and Phase 1 begins again.

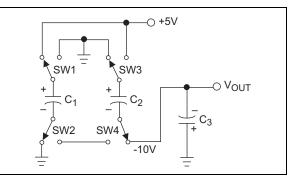


FIGURE 3-3: Charge Pump – Phase 2

3.3 Maximum Operating Limits

The TC682 has on-chip Zener diodes that clamp V_{IN} to approximately 5.8V, and V_{OUT} to -11.6V. Never exceed the maximum supply voltage or excessive current will be shunted by these diodes, potentially damaging the chip. The TC682 will operate over the entire operating temperature range with an input voltage of 2V to 5.5V.

3.4 Efficiency Considerations

Theoretically a charge pump voltage multiplier can approach 100% efficiency under the following conditions:

- The charge pump switches have virtually no offset and are extremely low on resistance.
- Minimal power is consumed by the drive circuitry.
- The impedances of the reservoir and pump capacitors are negligible.

For the TC682, efficiency is as shown below:

$$\begin{array}{l} \text{Voltage Efficiency} = \text{V}_{\text{OUT}} \ / \ (\text{-2V}_{\text{IN}}) \\ \text{V}_{\text{OUT}} = \text{-2V}_{\text{IN}} + \text{V}_{\text{DROP}} \\ \text{V}_{\text{DROP}} = (\text{I}_{\text{OUT}}) \ (\text{R}_{\text{OUT}}) \end{array} \end{array}$$

Power Loss $= I_{OUT} (V_{DROP})$

There will be a substantial voltage difference between V_{OUT} and $\text{-}2V_{\text{IN}}$ if the impedances of the pump capacitors C_1 and C_2 are high with respect to their respective output loads.

Larger values of reservoir capacitor C_3 will reduce output ripple. Larger values of both pump and reservoir capacitors improve the efficiency. See **Section 4.2** "**Capacitor Selection**" "Capacitor Selection".

4.0 TYPICAL APPLICATIONS

4.1 Negative Doubling Converter

The most common application of the TC682 is as a charge pump voltage converter which provides a negative output of two times a positive input voltage (Figure 4-1).

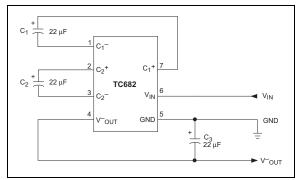


FIGURE 4-1:

Inverting Voltage Doubler

4.2 Capacitor Selection

The output resistance of the TC682 is determined, in part, by the ESR of the capacitors used. An expression for R_{OUT} is derived as shown below:

$$\begin{split} R_{OUT} &= 2(R_{SW1} + R_{SW2} + ESR_{C1} + R_{SW3} + R_{SW4} + ESR_{C2}) \\ &+ 2(R_{SW1} + R_{SW2} + ESR_{C1} + R_{SW3} + R_{SW4} + ESR_{C2}) \\ &+ 1/(f_{PUMP} \times C1) + 1/(f_{PUMP} \times C2) \\ &+ ESR_{C3} \end{split}$$

Assuming all switch resistances are approximately equal:

$$\begin{split} \mathsf{R}_{\mathsf{OUT}} &= \mathsf{16R}_{\mathsf{SW}} + \mathsf{4ESR}_{\mathsf{C1}} + \mathsf{4ESR}_{\mathsf{C2}} + \mathsf{ESR}_{\mathsf{C3}} \\ &\quad + \mathsf{1}/(\mathsf{f}_{\mathsf{PUMP}} \times \mathsf{C1}) + \mathsf{1}/(\mathsf{f}_{\mathsf{PUMP}} \times \mathsf{C2}) \end{split}$$

 R_{OUT} is typically 140 Ω at +25°C with V_{IN} = +5V and 3.3 μ F low ESR capacitors. The fixed term (16R_{SW}) is about 80-90 Ω . It can be seen easily that increasing or decreasing values of C1 and C2 will affect efficiency by changing R_{OUT}. However, be careful about ESR. This term can quickly become dominant with large electrolytic capacitors. Table 4-1 shows R_{OUT} for various values of C1 and C2 (assume 0.5 Ω ESR). C1 must be rated at 6VDC or greater while C2 and C3 must be rated at 12VDC or greater.

Output voltage ripple is affected by C3. Typically the larger the value of C3 the less the ripple for a given load current. The formula for $_{P-P}$ V_{RIPPLE} is given below:

 $V_{RIPPLE} = \{1/[2(f_{PUMP} \times C3)] + 2(ESR_{C3})\} (I_{OUT})$

For a 10 μ F (0.5 Ω ESR) capacitor for C3, f_{PUMP} = 10 kHz and I_{OUT} = 10 mA the peak-to-peak ripple voltage at the output will be less then 60 mV. In most applications (I_{OUT} < = 10 mA) a 10-20 μ F capacitor and 1-5 μ F pump capacitors will suffice. Table 4-2 shows V_{RIPPLE} for different values of C3 (assume 1 Ω ESR).

TABLE 4-1:	OUTPUT RESISTANCE
	VS. C1, C2

C1, C2 (μF)	R_{OUT}(Ω)
0.05	4085
0.10	2084
0.47	510
1.00	285
3.30	145
5.00	125
10.00	105
22.00	94
100.00	87

TABLE 4-2:	V _{RIPPLE} PEAK-TO-PEAK
	VS. C3 (I _{OUT} 10mA)

V _{RIPPLE} (mV)
1020
520
172
120
70
43
25

4.3 Paralleling Devices

Paralleling multiple TC682s reduces the output resistance of the converter. The effective output resistance is the output resistance of a single device divided by the number of devices. As illustrated in Figure , each requires separate pump capacitors C_1 and C_2 , but all can share a single reservoir capacitor.

4.4 -5V Regulated Supply From A Single 3V Battery

Figure 4-3 shows a -5V power supply using one 3V battery. The TC682 provides -6V at V_{OUT}, which is regulated to -5V by the negative LDO. The input to the TC682 can vary from 3V to 5.5V without affecting regulation appreciably. A TC54 device is connected to the battery to detect undervoltage. This unit is set to detect at 2.7V. With higher input voltage, more current can be drawn from the outputs of the TC682. With 5V at V_{IN}, 10 mA can be drawn from the regulated output. Assuming 150 Ω source resistance for the converter, with I_L⁻= 10 mA, the charge pump will droop 1.5V.

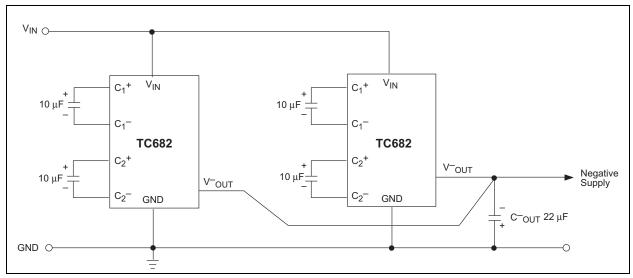


FIGURE 4-2: Paralleling TC682 for Lower Output Source Resistance

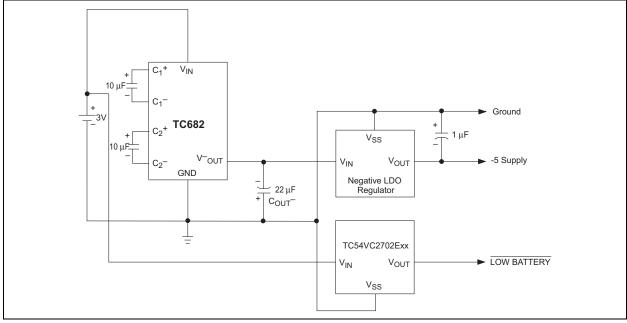


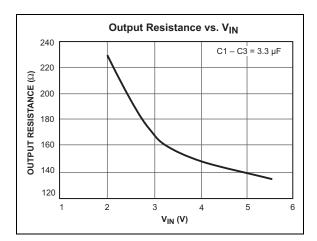
FIGURE 4-3: Negative Supply Derived from 3V Battery

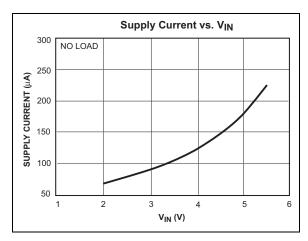
DS21453D-page 6

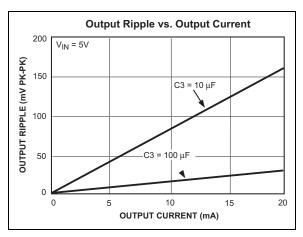
5.0 TYPICAL CHARACTERISTICS

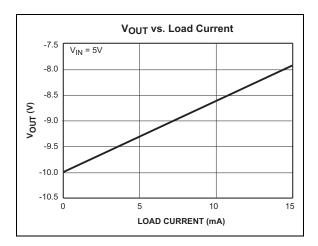
Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

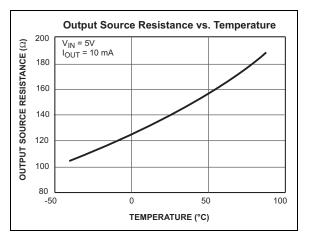
Circuit of Figure 3-1, $C_1 = C_2 = C_{OUT} = 3.3 \ \mu\text{F}$, $T_A = 25^{\circ}\text{C}$ unless otherwise noted.









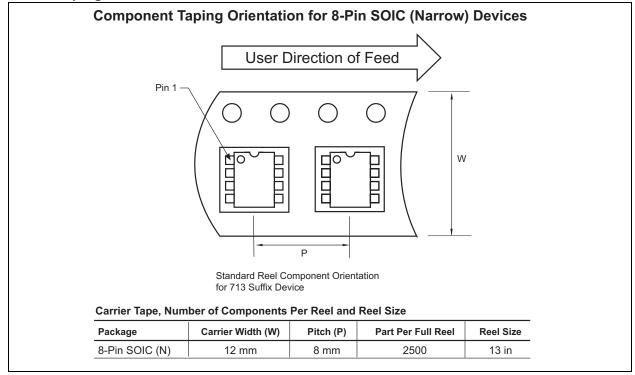


6.0 PACKAGING INFORMATION

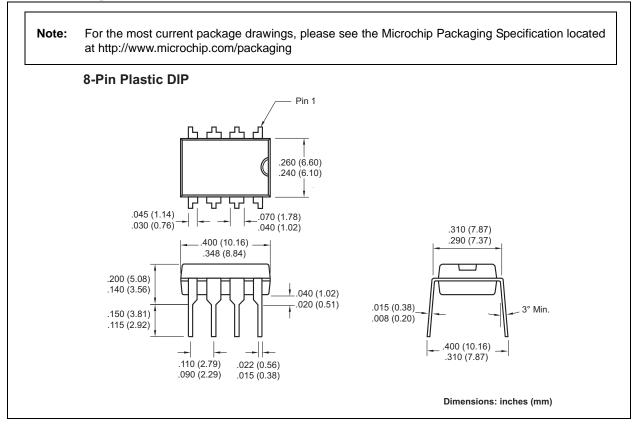
6.1 Package Marking Information

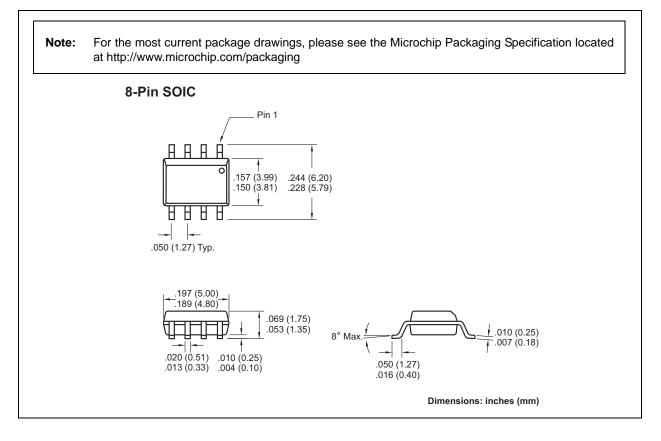
Package marking data not available at this time.

6.2 Taping Form



6.3 Package Dimensions





© 2002-2012 Microchip Technology Inc.

7.0 REVISION HISTORY

Revision D

Added a note to each package outline drawing.

THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://microchip.com/support

READER RESPONSE

It is our intention to provide you with the best documentation possible to ensure successful use of your Microchip product. If you wish to provide your comments on organization, clarity, subject matter, and ways in which our documentation can better serve you, please FAX your comments to the Technical Publications Manager at (480) 792-4150.

Please list the following information, and use this outline to provide us with your comments about this document.

TO: RE:	Technical Publications Manager Reader Response	Total Pages Sent			
From:	Name				
	Company				
	Address				
	City / State / ZIP / Country				
	Telephone: ()	FAX: ()			
Applic	cation (optional):				
Would	d you like a reply?YN				
Devic	e: TC682	Literature Number: DS21453D			
Quest	iions:				
1. W	hat are the best features of this document?				
- - 2 H	ow does this document meet your hardware and softwa	re development needs?			
2. 11	ow does this document meet your hardware and softwa				
_					
3. D	B. Do you find the organization of this document easy to follow? If not, why?				
_					
4. W	/hat additions to the document do you think would enha	nce the structure and subject?			
_					
5. W	. What deletions from the document could be made without affecting the overall usefulness?				
6. Is	there any incorrect or misleading information (what and	where)?			
_					
7. H	ow would you improve this document?				
_					
_					

DS21453D-page 12

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, FlashFlex, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC³² logo, rfPIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MTP, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

Analog-for-the-Digital Age, Application Maestro, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, SQI, Serial Quad I/O, Total Endurance, TSHARC, UniWinDriver, WiperLock, ZENA and Z-Scale are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

GestIC and ULPP are registered trademarks of Microchip Technology Germany II GmbH & Co. & KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2002-2012, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Rinted on recycled paper.

ISBN: 9781620768341

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and mulfacture of development systems is ISO 9001:2000 certified.

© 2002-2012 Microchip Technology Inc.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Cleveland Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto Mississauga, Ontario, Canada Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong Tel: 852-2401-1200 Fax: 852-2401-3431 Australia - Sydney

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Hangzhou Tel: 86-571-2819-3187 Fax: 86-571-2819-3189

China - Hong Kong SAR Tel: 852-2943-5100

Fax: 852-2401-3431 China - Nanjing

Tel: 86-25-8473-2460 Fax: 86-25-8473-2470 **China - Qingdao** Tel: 86-532-8502-7355

Fax: 86-532-8502-7205

China - Shanghai Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

China - Wuhan Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

China - Xiamen Tel: 86-592-2388138 Fax: 86-592-2388130

China - Zhuhai Tel: 86-756-3210040 Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

Japan - Osaka Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

Japan - Tokyo Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung Tel: 886-7-213-7828 Fax: 886-7-330-9305

Taiwan - Taipei Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

UK - Wokingham Tel: 44-118-921-5869 Fax: 44-118-921-5820